

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Operating Supply Voltage	V _P - V _N	6.0	V	-
DC Voltage at any Channel Input	-	(V _N – 0.5) to (V _P + 0.5)	V	-
Peak Pulse Current	IPP	5	A	8/20 μs, Per Fig. 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±8	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	$V_{ESD_{Air}}$	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 5)	PD	500	mW	
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	250	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Operating Supply Voltage	VP	-	3.3	5.5	V	-
Operating Supply Current (Note 6)	I _P	-	-	8.0	μA	$(V_{P} - V_{N}) = 3.3V$
Channel Leakage Current (Note 6)	I _R	-	0.1	1.0	μA	$V_{P} = 5V, V_{N} = 0V$
Reverse breakdown voltage	V _{BR}	6.0	-	-	V	I _R = 1mA
Clamping Voltage, Positive Transients	V _{CL1}	-	10.0	-	V	I _{PP} = 1A (Note 7)
Clamping Voltage, Negative Transients	V _{CL2}	-	-1.7	-	V	I _{PP} = -1A (Note 7)
Forward Voltage for Top Diode	V _{FD1}	0.60	0.80	0.95	V	$I_F = 8mA$, any channel to V_P
Forward Voltage for Bottom Diode	V _{FD2}	0.60	0.80	0.95	V	$I_F = 8mA$, V_N to and channel
Dynamic Resistance	R _{DYN}	-	0.9	-	Ω	I _{PP} = 1A (Note 7)
Channel Input Capacitance	Ст	-	0.85	1.2	pF	$V_{IN} = 1.65V, V_P = 3.3V, V_N = 0V, f = 1MHz$

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

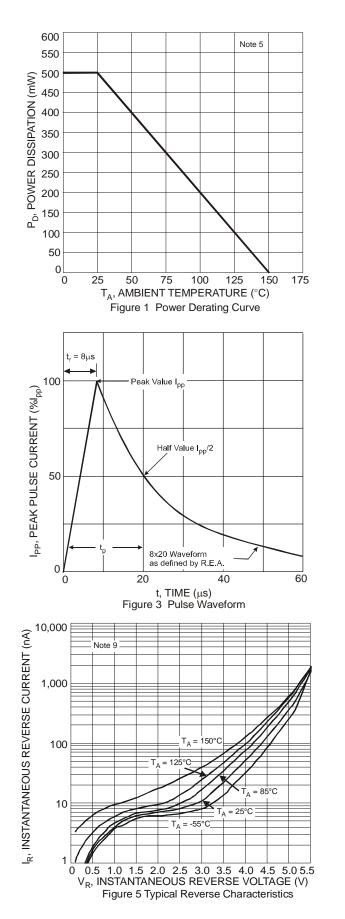
6. Short duration pulse test used to minimize self-heating effect.

7. Clamping voltage value is based on an $8x20\mu s$ peak pulse current (I_{pp}) waveform.

8. Measured from any channel to V_N 9. Measured from VP to VN.

10. For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote_dnote.html.





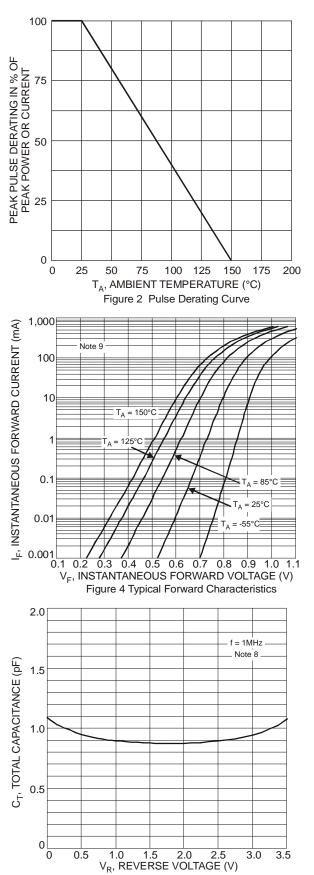
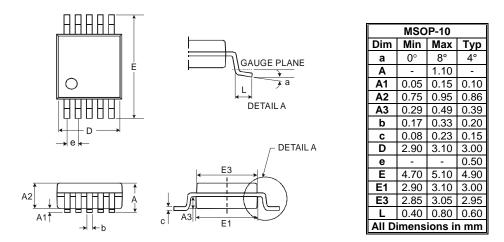


Figure 6 Typical Total Capacitance vs. Reverse Voltage



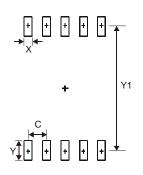
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	5.300
Х	0.300
Y	1.350
Y1	0.500



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